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B	NOTES: Mechanical: 1. Housing material : High Temp. Polyester UL94V-0, Color: Black ③③ 3. Contact material: Phosphor Bronze t=0.35mm 6u" Gold on contact area 100u"~200u" Tin on solder area all over 30u"~50u" Nickel ④ 4. Shell material: Copper Alloy 5. Shell plating: Nickel plated 6. Operating Life: 750 Cycles min. 7. PCB Retention Pre-solder: 1 LB min. 8. PCB Retention Post-solder: 10 LBS min. Electrical: 1. Voltage Rating: 125VAC. 2. Current Rating: 1.5AMP. 3. Contact Resistance: 45mΩ max. 4. Insulation Resistance: 1000MΩ min. @ 500 VDC 5. Dielectric Strength: 1000 VAC 60Hz, 1 min. Environmental: 1. Storage: -40°C To +85°C 2. Operation: -40°C~+85°C 3. Wave Soldering Temperature: 255°C~265°C 5~10S ⑧ Packing: 80pcs/Tray,1920pcs/Carton																																																															
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G	RoHS compliant Unit:mm File No.: E345352 <table><tr><th>Scale</th><th>Free</th><th>⑧ Update the packing quantity</th><th>21.12.2021</th><th>Peter</th><th>Date</th><th>Name</th><th>Description: Modular Jack Pitch 1.27 8Pin</th></tr><tr><td>TOLERANCE</td><td></td><td>⑦ Correct PEG dimensions</td><td>16.05.2016</td><td>Amy</td><td>Drawn</td><td>07.11.2007</td><td>N.Schulz</td></tr><tr><td>X.X</td><td>±0.20</td><td>⑥ Update the contact plating</td><td>25.08.2015</td><td>Amy</td><td>Approved</td><td>21.12.2021</td><td>Peter</td></tr><tr><td>X.XX</td><td>±0.15</td><td>⑤ Modify the dimensions</td><td>18.12.2014</td><td>Amy</td><td></td><td></td><td></td></tr><tr><td>X.XXX</td><td>±0.10</td><td>④ Update</td><td>27.05.2013</td><td>Amy</td><td></td><td></td><td></td></tr><tr><td>DIM</td><td>TOL</td><td>③ Add dimensions</td><td>02.07.2009</td><td>Dean</td><td></td><td></td><td></td></tr><tr><td>Angle</td><td>±5°</td><td>Id.</td><td>Modification</td><td>Date</td><td>Name</td><td></td><td></td></tr></table> ASSMANN components ASSMANN WSW-No. A-20042-LP/FS Drawing-No. ASS 0574 CO rev08 SHEET 1 / 1							Scale	Free	⑧ Update the packing quantity	21.12.2021	Peter	Date	Name	Description: Modular Jack Pitch 1.27 8Pin	TOLERANCE		⑦ Correct PEG dimensions	16.05.2016	Amy	Drawn	07.11.2007	N.Schulz	X.X	±0.20	⑥ Update the contact plating	25.08.2015	Amy	Approved	21.12.2021	Peter	X.XX	±0.15	⑤ Modify the dimensions	18.12.2014	Amy				X.XXX	±0.10	④ Update	27.05.2013	Amy				DIM	TOL	③ Add dimensions	02.07.2009	Dean				Angle	±5°	Id.	Modification	Date	Name			
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